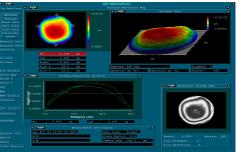


Challenge the next generation with ceramics!

Ultraprecise Vacuum Chuck

Combined state-of-the-art technology of flat machining and precise machining realizes stable and ultraprecise wafer clamping and decreases particle and scratch of wafer backside

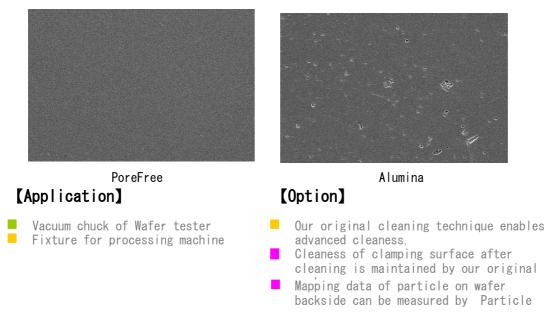


Data of Laser Interferometer for 12" Chuck

[Feature]

- High precision : Flatness 0.5 μ m, L/F 0.1 μ m
- Available material : Crystallized glass , SiC, Conductiv
- Shape control: Tailored shape fits wafer
- Low particle: Porefree material and Special polishing

Surface microstructure of chuck material (SEM)



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